

Amendments to the Specification

Please replace the Title with the following amended Title:

~~Semiconductor Constructions~~ and Methods of Forming Semiconductor Constructions

Please add the following new paragraph at page 1, after the Title:

-- RELATED PATENT DATA

This application is a divisional of U.S. Patent Application No.: 10/364,054 filed on February 10, 2003, which is a divisional of U.S. Patent Application No.: 10/299,336, filed on August 26, 2002.--